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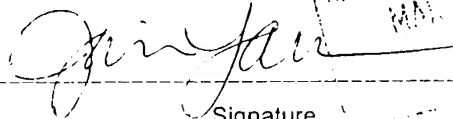
**REQUEST TO RESCIND PREVIOUS
NONPUBLICATION REQUEST
35 U.S.C. 122(b)(2)(B)(ii)**

Application Number	10/031,564
Filing Date	2/22/02
First Named Inventor	Victor Kadziela
Title	SOFT MOLDING COMPOUND
Atty Docket Number	500-151 (LC-442)
Group Art Unit	1711
Examiner	Unassigned

I hereby **rescind** the previous request that the above-identified application not be published under 35 U.S.C. 122(b).

2/27/03

Date



Signature

Jamie M. Larmann

Typed or printed name

Reg. No. 48,623

This request must be signed in compliance with 37 CFR 1.33(b).

Note: Filing this rescission of a previous nonpublication request is considered the notice of a subsequent foreign or International filing required by 35 USC 122(b)(2)(B)(iii) and 37 CFR 1.213(c) if this rescission is filed no later than forty-five days (45) days after the date of filing of such foreign or international application. See 37 CFR 1.137(f) if a notice of subsequent foreign or International filing required by 35 USC 122(b)(2)(B)(iii) and 37 CFR 1.213(c) is **not** filed within forty-five days (45) days after the date of filing of the foreign or international application.

CERTIFICATE OF MAILING OR TRANSMISSION

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